ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- Uniform light output.
- Low power consumption.
- Long life-solid state reliability.
- RoHS compliant.

T-1 3/4 (5mm) FULL COLOR LED LAMP

Part Number: WP154A4SUREQBFZGC

Hyper Red Blue Green

Description

The Hyper Red source color devices are made with Al-GalnP on GaAs substrate Light Emitting Diode.

The Blue source color devices are made with InGaN Light Emitting Diode.

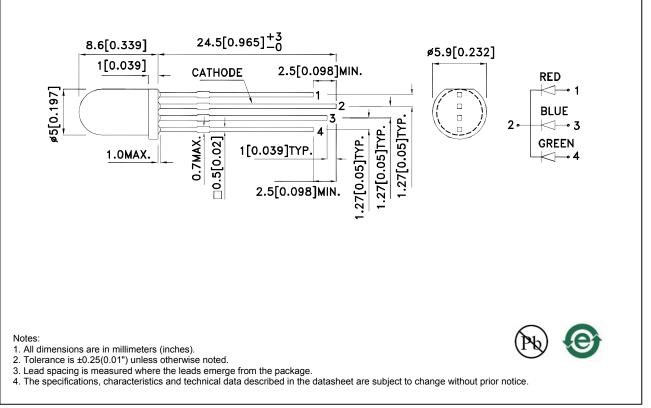
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
WP154A4SUREQBFZGC	Hyper Red (AlGaInP)		650	1300	50°
	Blue (InGaN)	Water Clear	500	1100	
	Green (InGaN)		1000	1700	

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Blue Green	640 461 515		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red Blue Green	630 465 525		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Blue Green	25 25 30		nm	I⊧=20mA
С	Capacitance	Hyper Red Blue Green	45 100 45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Blue Green	1.9 3.3 3.3	2.5 4 4.1	V	IF=20mA
lr	Reverse Current	Hyper Red Blue Green		10 50 50	uA	Vr=5V

Electrical / Optical Characteristics at TA=25°C

Notes:

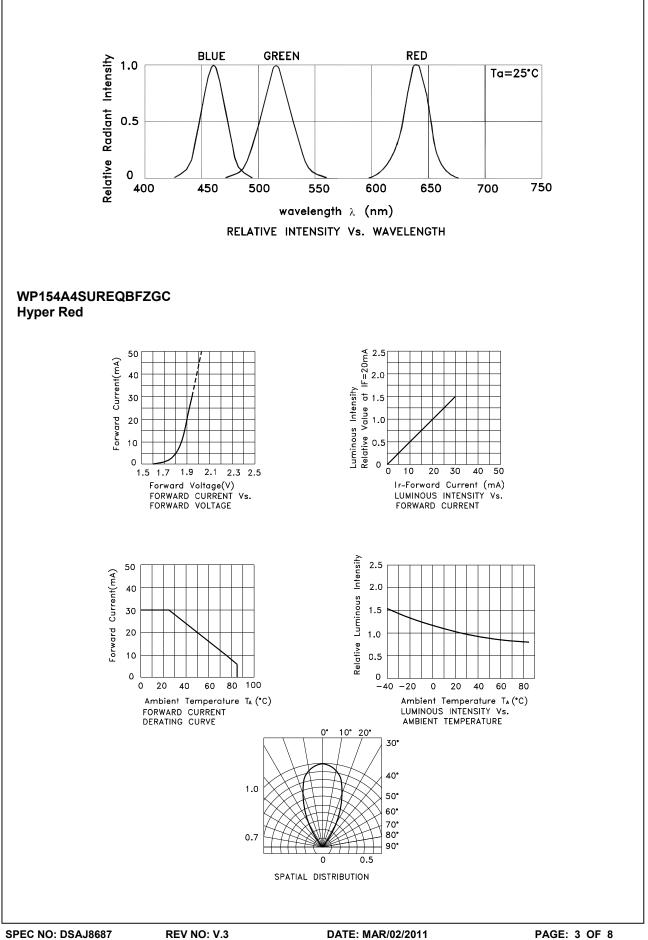
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

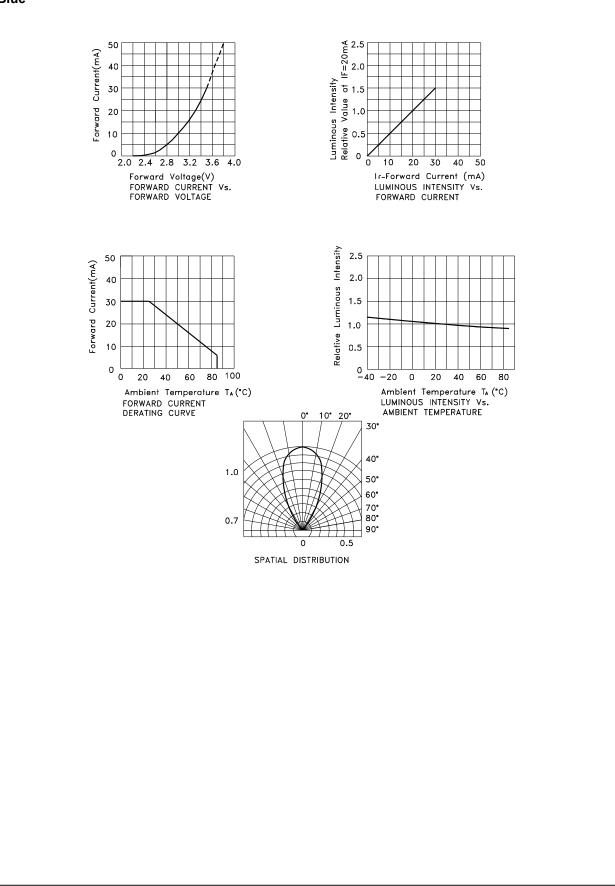
Parameter	Hyper Red	Blue	Green	Units		
Power dissipation	75	120	102.5	mW		
DC Forward Current	30	30	25	mA		
Peak Forward Current [1]	200	150	150	mA		
Reverse Voltage			V			
Operating/Storage Temperature	-40°C To +85°C					
Lead Solder Temperature [2]	260°C For 3 Seconds					
Lead Solder Temperature [3]	260°C For 5 Seconds					

Notes:

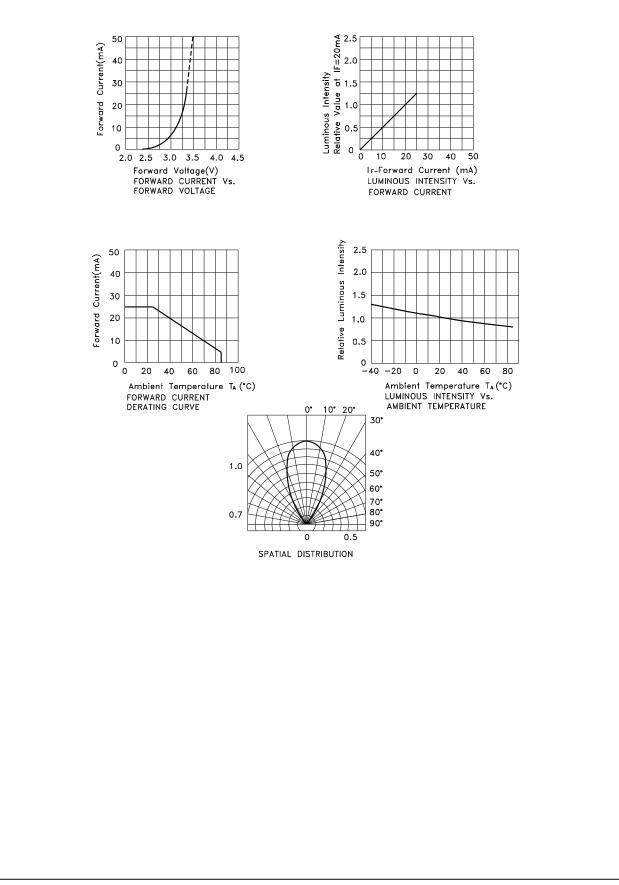
1.1/10 Duty Cycle, 0.1ms Pulse Width.
2.2mm below package base.
3.5mm below package base.

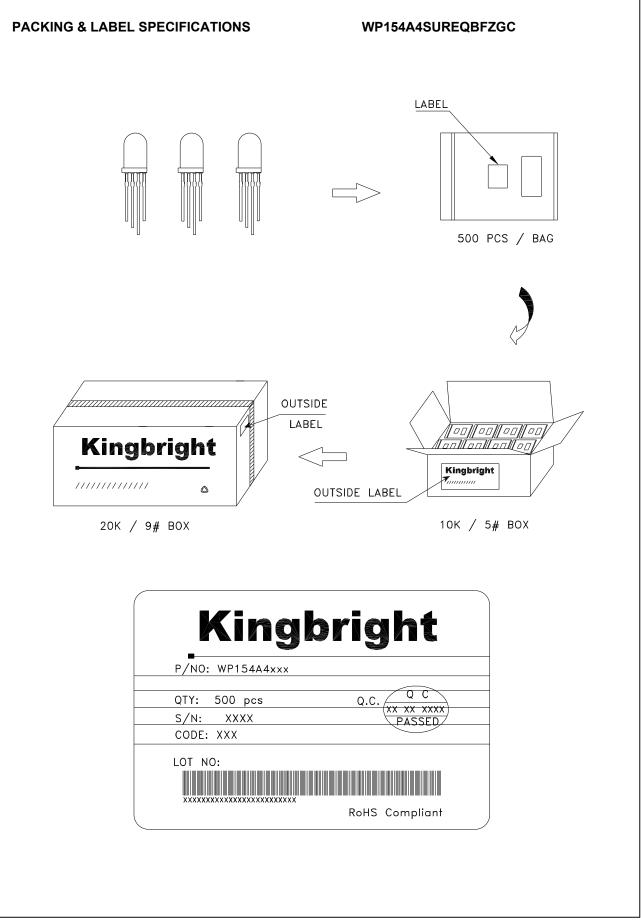


Blue



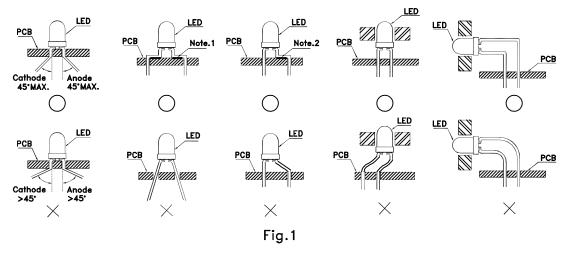
Green



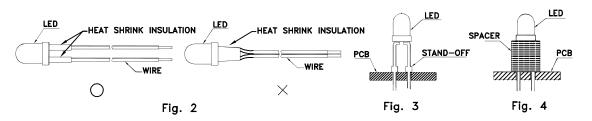


PRECAUTIONS

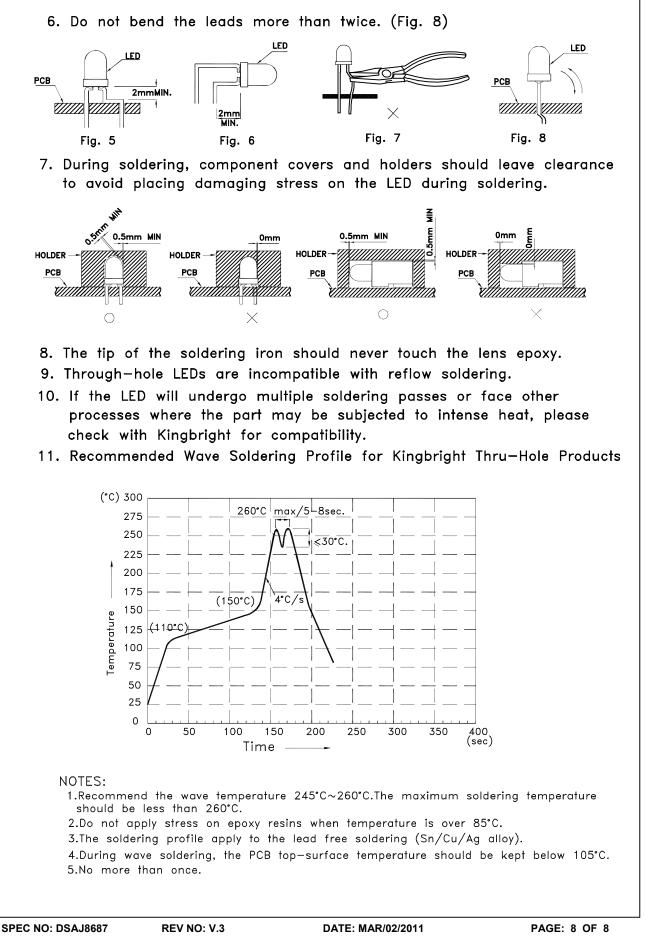
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



- \supset " Correct mounting method "imes " Incorrect mounting method
- When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)
- 3.Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



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Mouser Electronics

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Kingbright: WP154A4SUREQBFZGC